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JC962 U.S. PTO
12/27/01

PATENT

Docket No. JCLA8242

Date: 12-27-2001

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JC714 U.S. PTO
10/034876
12/27/01

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231
ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Chung-Liang Hsiao, Chien-Hsin Ko
For: METHOD OF FORMING A BUMP

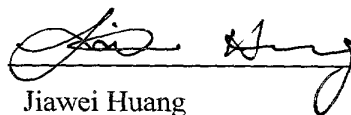
Enclosed are:

- ☒ Specification 12 pages.
- ☒ 6 Sheets of drawings
- ☒ Recordation Form Cover sheet with 2 pages assignment.
- ☐ A certified copy of Taiwan Patent Application No. dated .
- ☒ **SIGNED** declaration and power of attorney.
- ☒ Return Prepaid postcard.

CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$370.00	\$370.00
Total Claims	11 — 20 = 0 ×		\$9.00	\$0.00
Independent Claims	2 — 3 = 0 ×		\$42.00	\$0.00
If application contains any multiple dependent claim (s), then add			\$140.00	\$0.00
TOTAL FILING FEE				\$370.00

- ☒ A check in the amount of \$370.00 cover the filing fee is enclosed.
- ☒ A check in the amount of \$40.00 to cover the assignment recording fee.
- ☒ A duplicate copy of this sheet is enclosed.
- ☒ **Applicant claims small entity status. See 37 CFR 1.27**



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CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No. : JCLA8242
Applicant(s) : Chung-Liang Hsiao, Chien-Hsin Ko
For : METHOD OF FORMING A BUMP
"Express Mail" : EV 016847023 US
Mailing Label No.

Date of Deposit : December 27, 2001

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 12 pages, 6 sheets of drawings; **SIGNED**
Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and
Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.


Michelle Chang